

### **AMENDMENTS TO THE SPECIFICATION**

Please replace the Paragraph beginning on page 7, line 3 with the following paragraph rewritten in amendment format:

As a manufacturing method for the microstructures ~~13~~ 12, and a method of setting these in the concavities 11, the methods disclosed for example in U.S. Patent Nos. 5904545, 5824186, 5783856 and 5545291 may be applied. Furthermore, for the depositing method for the protective film 13, the method of opening the through holes 13a, and the patterning method for the wiring 14, known depositing methods and photolithography processes may be adopted.